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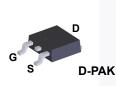
## FCD900N60Z N-Channel SuperFET<sup>®</sup> II MOSFET 600 V, 4.5 A, 900 mΩ

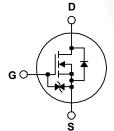
## Features

- 650 V @ T<sub>1</sub> = 150°C
- Typ. R<sub>DS(on)</sub> = 820 mΩ
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 13 nC)
- Low Effective Output Capacitance (Typ. C<sub>oss(eff.)</sub> = 49 pF)
- 100% Avalanche Tested
- · ESD Improved Capacity
- RoHS Compliant

### Applications

- LCD / LED / PDP TV and Monitor Lighting
- Solar Inverter
- Charger





SuperFET<sup>®</sup> II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing

charge balance technology for outstanding low on-resistance

and lower gate charge performance. This technology is tailored

to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently,

SuperFET II MOSFET is very suitable for the switching power

applications such as PFC, server/telecom power, FPD TV

power, ATX power and industrial power applications.

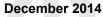
Description

## Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

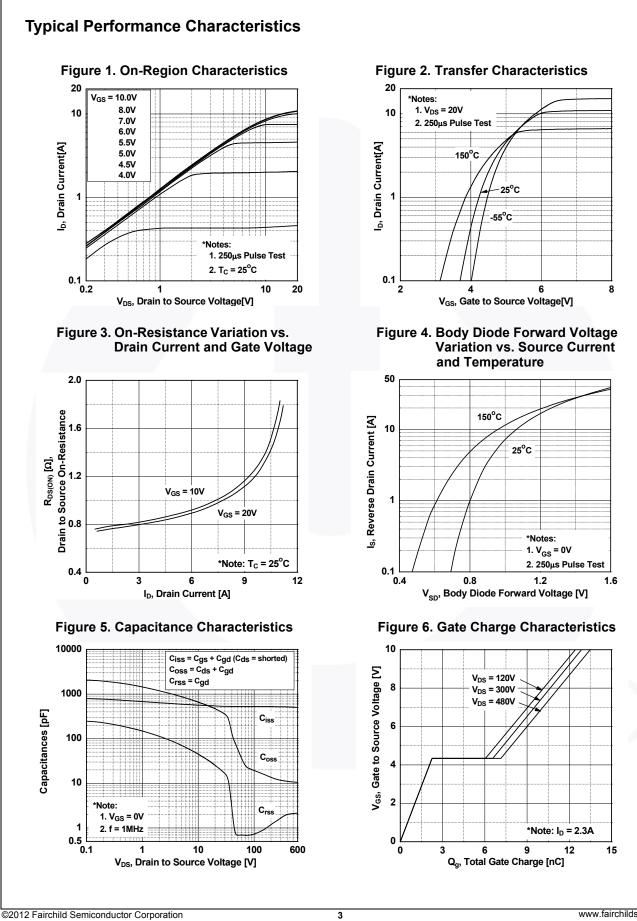
Symbol		Parameter		FCD900N60Z	Unit	
V <sub>DSS</sub>	Drain to Source Voltage	rain to Source Voltage		600	V	
V <sub>GSS</sub>		- DC		±20	V	
	Gate to Source Voltage	- AC (	f > 1Hz)	±30	V	
I <sub>D</sub> Drain Curre	Desis Ourset	- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)		4.5		
	Drain Current	- Continuous (T <sub>C</sub> = 100 <sup>o</sup> C)		3.5	A	
DM	Drain Current	- Pulsed	(Note 1)	13.5	Α	
AS	Single Pulsed Avalanche Energy (Note 2)		47.5	mJ		
AR	Avalanche Current (Note 1)		(Note 1)	1	Α	
AR	Repetitive Avalanche Energy (Note 1)		0.52	mJ		
dv/dt	MOSFET dv/dt		100	Mag		
	Peak Diode Recovery dv/dt (Note 3)		20	V/ns		
P <sub>D</sub>	Devuer Discinction	(T <sub>C</sub> = 25°C)		52	W	
	Power Dissipation	- Derate Above 25°C		0.42	W/ºC	
Γ <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C		
ΓL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C		

## **Thermal Characteristics**

Symbol	Parameter	FCD900N60Z	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	2.4	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	100	°C/W



DPAK 25°C unless of oltage ure eakdown ent Forward Reverse iistance	Tape and Reel         Tape and Reel         otherwise noted.         Test Conditio $V_{GS} = 0 V$ , $I_D = 10 mA$ , T $V_{GS} = 0 V$ , $I_D = 10 mA$ , T $I_D = 10 mA$ , Referenced $V_{GS} = 0 V$ , $I_D = 4.5 A$ $V_{DS} = 480 V$ , $V_{GS} = 0 V$ $V_{BS} = 480 V$ , $V_{CS} = 0 V$ $V_{GS} = 20 V$ , $V_{DS} = 0 V$ $V_{GS} = -20 V$ , $V_{DS} = 0 V$ $V_{GS} = 10 V$ , $I_D = 2.3 A$ $V_{DS} = 25 V$ , $V_{GS} = 0 V$ , $V_{DS} = 25 V$ , $V_{GS} = 0 V$ , $V_{DS} = 380 V$ , $V_{GS} = 0 V$ ,	$T_{\rm J} = 25^{\circ}{\rm C}$ $T_{\rm J} = 150^{\circ}{\rm C}$ to 25 <sup>o</sup> C	Min. 600 650 - - - 2.5 - - 2.5 - - - - - - - - - - - - -	6 mm <b>Typ.</b> - 0.67 700 - - - 0.82 4.6 543	2500 Max. - - - - 5 20 10 -10 - 10 - 10 - 10 - - 0.90 -	units Unit V/°C V/°C V/°C V ν υΑ uA uA V uA
oltage ure eakdown ent Forward Reverse	$\begin{tabular}{ c c c c } \hline Test Conditio \\ \hline V_{GS} = 0 \ V, \ I_D = 10 \ mA, \ T \\ \hline V_{GS} = 0 \ V, \ I_D = 10 \ mA, \ T \\ \hline I_D = 10 \ mA, \ Referenced \\ \hline V_{GS} = 0 \ V, \ I_D = 4.5 \ A \\ \hline V_{DS} = 480 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 480 \ V, \ T_C = 125^{00} \\ \hline V_{GS} = 20 \ V, \ V_{DS} = 0 \ V \\ \hline V_{GS} = -20 \ V, \ V_{DS} = 0 \ V \\ \hline V_{GS} = 10 \ V, \ I_D = 2.3 \ A \\ \hline V_{DS} = 20 \ V, \ I_D = 2.3 \ A \\ \hline V_{DS} = 25 \ V, \ V_{GS} = 0 \ V, \\ \hline - f = 1 \ MHz \\ \hline \end{tabular}$	$T_{\rm J} = 25^{\circ}{\rm C}$ $T_{\rm J} = 150^{\circ}{\rm C}$ to 25 <sup>o</sup> C	600 650 - - - - - 2.5 - - -	- - - - - - - - - - - - - - - - - - -	- - - 5 20 10 -10 3.5	V 20°/V V V V Au Au Au Ω
oltage ure eakdown ent Forward Reverse	$\begin{tabular}{ c c c c } \hline Test Conditio \\ \hline V_{GS} = 0 \ V, \ I_D = 10 \ mA, \ T \\ \hline V_{GS} = 0 \ V, \ I_D = 10 \ mA, \ T \\ \hline I_D = 10 \ mA, \ Referenced \\ \hline V_{GS} = 0 \ V, \ I_D = 4.5 \ A \\ \hline V_{DS} = 480 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 480 \ V, \ T_C = 125^{00} \\ \hline V_{GS} = 20 \ V, \ V_{DS} = 0 \ V \\ \hline V_{GS} = -20 \ V, \ V_{DS} = 0 \ V \\ \hline V_{GS} = 10 \ V, \ I_D = 2.3 \ A \\ \hline V_{DS} = 20 \ V, \ I_D = 2.3 \ A \\ \hline V_{DS} = 25 \ V, \ V_{GS} = 0 \ V, \\ \hline - f = 1 \ MHz \\ \hline \end{tabular}$	$T_{\rm J} = 25^{\circ}{\rm C}$ $T_{\rm J} = 150^{\circ}{\rm C}$ to 25 <sup>o</sup> C	600 650 - - - - - 2.5 - - -	- - - - - - - - - - - - - - - - - - -	- - - 5 20 10 -10 3.5	V 20°/V V V V Au Au Au Ω
eakdown ent Forward Reverse	$\begin{split} & V_{GS} = 0 \; V, \; I_{D} = 10 \; mA, \; T \\ & I_{D} = 10 \; mA, \; Referenced \\ & V_{GS} = 0 \; V, \; I_{D} = 4.5 \; A \\ & V_{DS} = 480 \; V, \; V_{GS} = 0 \; V \\ & V_{DS} = 480 \; V, \; T_{C} = 125^{\circ} O \\ & V_{GS} = 20 \; V, \; V_{DS} = 0 \; V \\ & V_{GS} = 20 \; V, \; V_{DS} = 0 \; V \\ & V_{GS} = -20 \; V, \; V_{DS} = 0 \; V \\ & V_{GS} = 10 \; V, \; I_{D} = 2.50 \; \mu A \\ & V_{DS} = 20 \; V, \; I_{D} = 2.3 \; A \\ & V_{DS} = 20 \; V, \; I_{D} = 2.3 \; A \\ & V_{DS} = 25 \; V, \; V_{GS} = 0 \; V, \\ & f = 1 \; MHz \end{split}$	「 <sub>J</sub> = 150°C to 25 <sup>°</sup> C	650 - - - - - - - - - - - - - - - - - - -	- - - - - - - - - - - - - - - - - - -	- - 5 20 10 -10 3.5	V/°C V μΑ μΑ μΑ ν Δ
eakdown ent Forward Reverse	$\begin{split} & V_{GS} = 0 \; V, \; I_{D} = 10 \; mA, \; T \\ & I_{D} = 10 \; mA, \; Referenced \\ & V_{GS} = 0 \; V, \; I_{D} = 4.5 \; A \\ & V_{DS} = 480 \; V, \; V_{GS} = 0 \; V \\ & V_{DS} = 480 \; V, \; T_{C} = 125^{\circ} O \\ & V_{GS} = 20 \; V, \; V_{DS} = 0 \; V \\ & V_{GS} = 20 \; V, \; V_{DS} = 0 \; V \\ & V_{GS} = -20 \; V, \; V_{DS} = 0 \; V \\ & V_{GS} = 10 \; V, \; I_{D} = 2.50 \; \mu A \\ & V_{DS} = 20 \; V, \; I_{D} = 2.3 \; A \\ & V_{DS} = 20 \; V, \; I_{D} = 2.3 \; A \\ & V_{DS} = 25 \; V, \; V_{GS} = 0 \; V, \\ & f = 1 \; MHz \end{split}$	「 <sub>J</sub> = 150°C to 25 <sup>°</sup> C	650 - - - - - - - - - - - - - - - - - - -	- 0.67 700 - - - 0.82 4.6	- - 5 20 10 -10 3.5	V/°C V μΑ μΑ μΑ ν Δ
eakdown ent Forward Reverse	$\begin{split} & V_{GS} = 0 \; V, \; I_{D} = 10 \; mA, \; T \\ & I_{D} = 10 \; mA, \; Referenced \\ & V_{GS} = 0 \; V, \; I_{D} = 4.5 \; A \\ & V_{DS} = 480 \; V, \; V_{GS} = 0 \; V \\ & V_{DS} = 480 \; V, \; T_{C} = 125^{\circ} O \\ & V_{GS} = 20 \; V, \; V_{DS} = 0 \; V \\ & V_{GS} = 20 \; V, \; V_{DS} = 0 \; V \\ & V_{GS} = -20 \; V, \; V_{DS} = 0 \; V \\ & V_{GS} = 10 \; V, \; I_{D} = 2.50 \; \mu A \\ & V_{DS} = 20 \; V, \; I_{D} = 2.3 \; A \\ & V_{DS} = 20 \; V, \; I_{D} = 2.3 \; A \\ & V_{DS} = 25 \; V, \; V_{GS} = 0 \; V, \\ & f = 1 \; MHz \end{split}$	「 <sub>J</sub> = 150°C to 25 <sup>°</sup> C	- - - - 2.5 - - -	700 - - - - 0.82 4.6	- 5 20 10 -10 3.5	V/°C V μΑ μΑ μΑ ν Δ
eakdown ent Forward Reverse	$V_{GS} = 0 \text{ V}, I_D = 4.5 \text{ A}$ $V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 480 \text{ V}, T_C = 125^{\circ}(0)$ $V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$ $V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$ $V_{GS} = 10 \text{ V}, I_D = 2.3 \text{ A}$ $V_{DS} = 20 \text{ V}, I_D = 2.3 \text{ A}$ $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ $f = 1 \text{ MHz}$		- - - 2.5 - -	700 - - - - 0.82 4.6	- 5 20 10 -10 3.5	V Aμ Au Au V Ω
ent Forward Reverse	$V_{DS} = 480 V, V_{GS} = 0 V$ $V_{DS} = 480 V, T_{C} = 125^{\circ}(V_{GS} = 20 V, V_{DS} = 0 V)$ $V_{GS} = 20 V, V_{DS} = 0 V$ $V_{GS} = -20 V, V_{DS} = 0 V$ $V_{GS} = 10 V, I_{D} = 2.3 A$ $V_{DS} = 20 V, I_{D} = 2.3 A$ $V_{DS} = 25 V, V_{GS} = 0 V,$ $f = 1 MHz$		- - - 2.5 - -	- - - 0.82 4.6	5 20 10 -10 3.5	μΑ μΑ μΑ μΑ ν Α
Forward Reverse	$V_{DS} = 480 \text{ V},  \text{T}_{C} = 125^{\circ}\text{G}$ $V_{GS} = 20 \text{ V},   \text{V}_{DS} = 0 \text{ V}$ $V_{GS} = -20 \text{ V},     \text{V}_{DS} = 0 \text{ V}$ $V_{GS} = 10         $		- - 2.5 - -	0.82 4.6	20 10 -10 3.5	uA uA UA V Ω
Forward Reverse	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$ $V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$ $V_{GS} = V_{DS}, I_D = 250 \mu\text{A}$ $V_{GS} = 10 \text{ V}, I_D = 2.3 \text{ A}$ $V_{DS} = 20 \text{ V}, I_D = 2.3 \text{ A}$ $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ $f = 1 \text{ MHz}$		- - 2.5 - - -	0.82 4.6	10 -10 3.5	uA uA UA V Ω
Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$ $V_{GS} = V_{DS}, I_D = 250 \mu\text{A}$ $V_{GS} = 10 \text{ V}, I_D = 2.3 \text{ A}$ $V_{DS} = 20 \text{ V}, I_D = 2.3 \text{ A}$ $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ $f = 1 \text{ MHz}$		2.5 - -	0.82 4.6	-10 3.5	uA V Ω
istance	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$ $V_{GS} = 10 \ V, I_D = 2.3 \ A$ $V_{DS} = 20 \ V, I_D = 2.3 \ A$ $V_{DS} = 25 \ V, V_{GS} = 0 \ V,$ $f = 1 \ MHz$		2.5 - -	0.82 4.6	3.5	V Ω
	$V_{GS} = 10 \text{ V}, I_D = 2.3 \text{ A}$ $V_{DS} = 20 \text{ V}, I_D = 2.3 \text{ A}$ $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1  MHz		-	0.82 4.6		Ω
	$V_{GS} = 10 \text{ V}, I_D = 2.3 \text{ A}$ $V_{DS} = 20 \text{ V}, I_D = 2.3 \text{ A}$ $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1  MHz		-	0.82 4.6		Ω
	$V_{GS} = 10 \text{ V}, I_D = 2.3 \text{ A}$ $V_{DS} = 20 \text{ V}, I_D = 2.3 \text{ A}$ $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1  MHz		-	0.82 4.6		Ω
	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 2.3 \text{ A}$ $V_{DS} = 25 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1  MHz			4.6	-	
	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1 MHz					0
2	f = 1 MHz	_		543		
	f = 1 MHz	_		543		
l	f = 1 MHz	_	-		720	pF
}				400	530	pF
	$V_{DO} = 380 \text{ V} \text{ V}_{OO} = 0 \text{ V}$		-	20	30	pF
	105 000 1, 165 0 1,	f = 1 MHz	-	11	-	pF
	$V_{DS}$ = 0 V to 480 V, $V_{GS}$	= 0 V	-	49	-	pF
	V <sub>DS</sub> = 380 V, I <sub>D</sub> = 2.3 A, V <sub>GS</sub> = 10 V		-	13	17	nC
			-	2.3	-	nC
		(Note 4)	-	4.8	-	nC
	f = 1 MHz		-	2.4	-	Ω
rn-On Delay Time		<u></u>	10.9	32	ns	
	$V_{DD}$ = 380 V, I <sub>D</sub> = 2.3 A, $V_{GS}$ = 10 V, R <sub>G</sub> = 4.7 $\Omega$ (Note 4)		-	5.3	21	ns
			-	33.6	77	ns
			-	11.9	34	ns
		( ,				<u> </u>
	Enward Current				4.5	A
Pulsed Drain to Source Diode Forward Current			_			A
	I		_			V
i voltage				156	1.2	ns
						μC
		Source Diode Forward Current         rce Diode Forward Current         d Voltage $V_{GS} = 0 \text{ V}, \text{ I}_{SD} = 2.3 \text{ A}$ $V_{GS} = 0 \text{ V}, \text{ I}_{SD} = 2.3 \text{ A},$ $dI_F/dt = 100 \text{ A}/\mu\text{s}$ temperature.	Source Diode Forward Current       Image: Current forward Current         Image: VGS = 0 V, ISD = 2.3 A       Image: Current forward Current forward Current         Image: VGS = 0 V, ISD = 2.3 A       Image: Current forward Current forward Current forward Current         Image: VGS = 0 V, ISD = 2.3 A       Image: Current forward C	Source Diode Forward Current       -         rce Diode Forward Current       -         d Voltage $V_{GS} = 0 V, I_{SD} = 2.3 A$ - $V_{GS} = 0 V, I_{SD} = 2.3 A,$ - $V_{GS} = 0 V, I_{SD} = 2.3 A,$ - $dI_F/dt = 100 A/\mu s$ -         temperature.	Source Diode Forward Currentrce Diode Forward Currentd Voltage $V_{GS} = 0 V$ , $I_{SD} = 2.3 A$ - $V_{GS} = 0 V$ , $I_{SD} = 2.3 A$ ,-156 $dI_F/dt = 100 A/\mu s$ -1.3	Source Diode Forward Current       -       -       4.5         rce Diode Forward Current       -       -       13.5         d Voltage $V_{GS} = 0 V, I_{SD} = 2.3 A$ -       -       1.2 $V_{GS} = 0 V, I_{SD} = 2.3 A,$ -       156       - $V_{GS} = 0 V, I_{SD} = 2.3 A,$ -       1.3       - $V_{GS} = 0 V, I_{SD} = 2.3 A,$ -       1.3       - $V_{GS} = 0 V, I_{SD} = 2.3 A,$ -       1.3       - $V_{GS} = 0 V, I_{SD} = 2.3 A,$ -       1.3       - $V_{GS} = 0 V, I_{SD} = 2.3 A,$ -       1.3       -



FCD900N60Z Rev. C4



\*Notes:

100

50 75 100 T<sub>C</sub>, Case Temperature [<sup>°</sup>C]

1. V<sub>GS</sub> = 10V

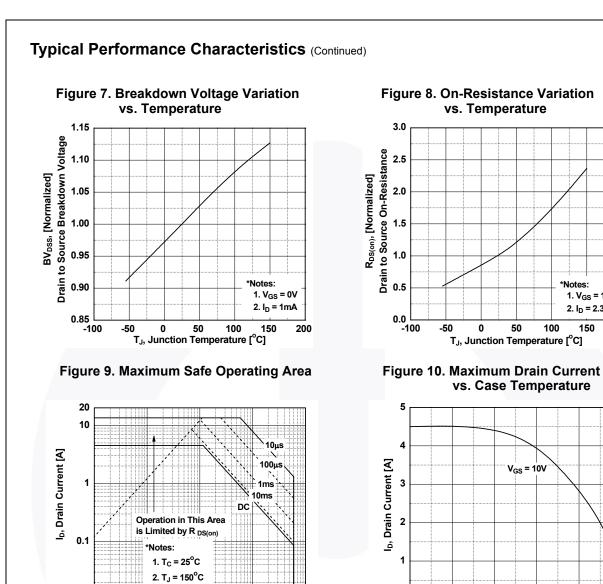
2. I<sub>D</sub> = 2.3A

150

125

150

200



3. Single Pulse

1

10

V<sub>DS</sub>, Drain to Source Voltage [V]

Figure 11. Eoss vs. Drain to Source Voltage

100 200 300 400 500 V<sub>DS</sub>, Drain to Source Voltage [V]

100



100

0.01

2.8

2.4

2.0

1.2

0.8

0.4

0.0 l⁄2 0

E<sub>oss</sub>, [µJ] 1.6

0.1

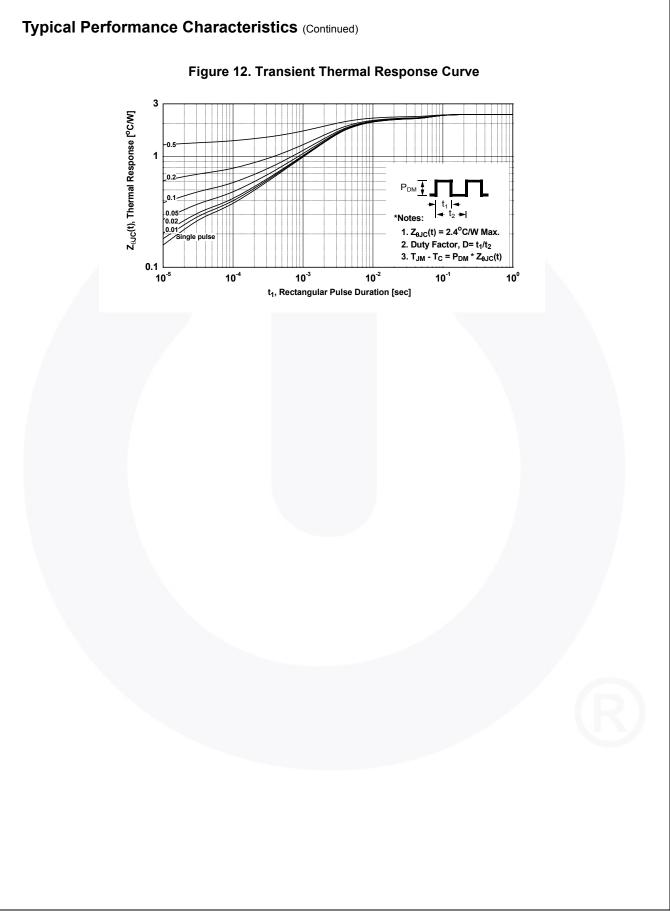
4

0 ∟ 25

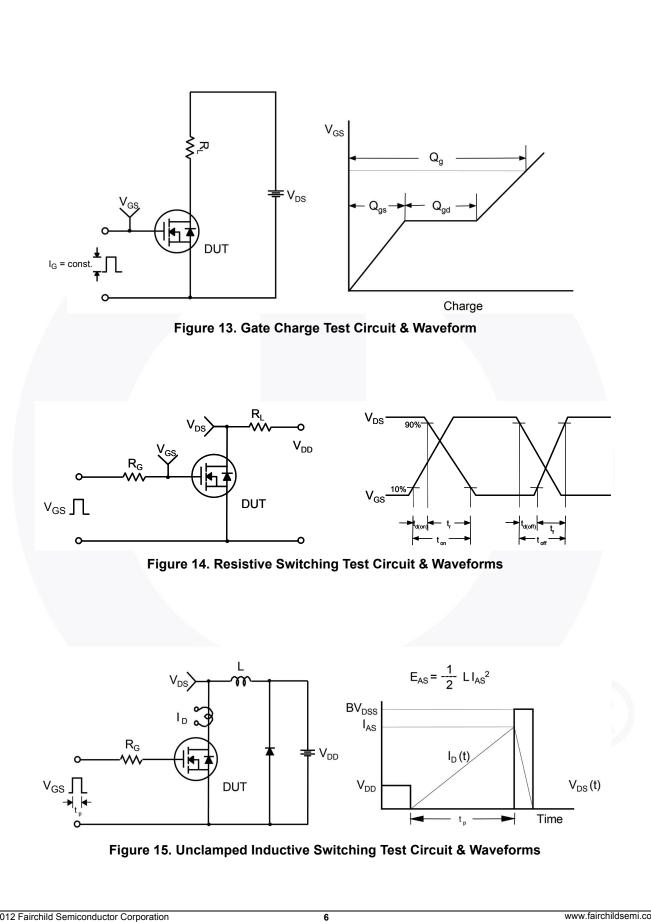
50

1000

600



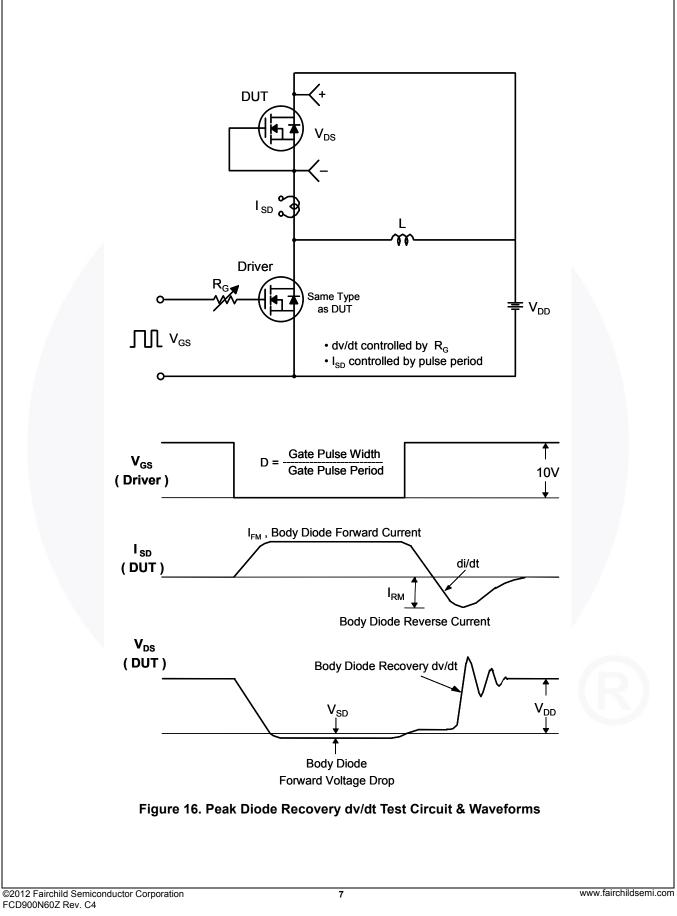
FCD900N60Z — N-Channel SuperFET<sup>®</sup> II MOSFET

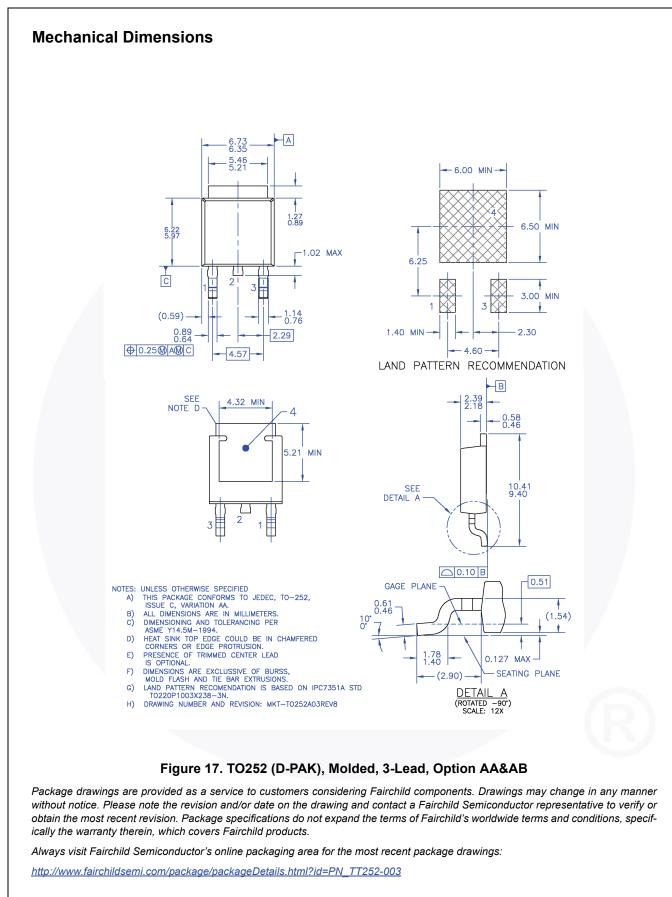


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